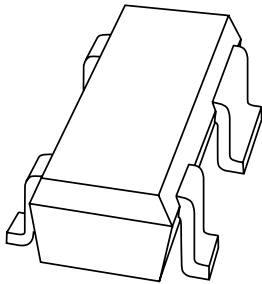


# DATA SHEET



## **BFU510** NPN SiGe wideband transistor

Preliminary specification

2001 Nov 08

# NPN SiGe wideband transistor

# BFU510

## FEATURES

- Very high power gain
- Very low noise figure
- High transition frequency
- Emitter is thermal lead
- Low feedback capacitance
- 45 GHz SiGe process.

## APPLICATIONS

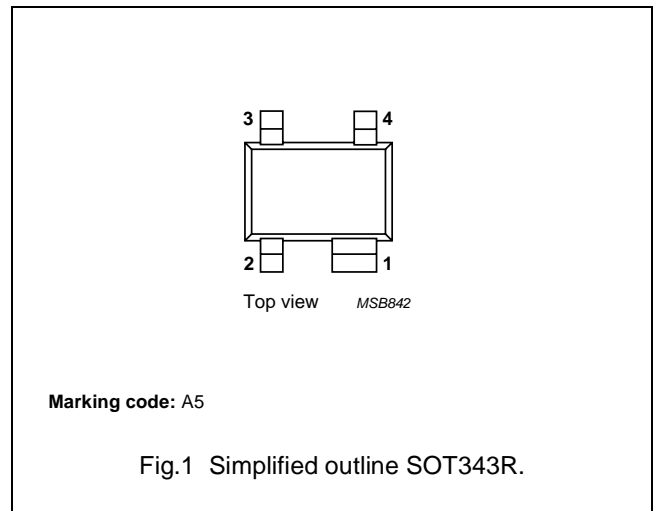
- RF front end
- Wideband applications, e.g. analog and digital cellular telephones, cordless telephones (PHS, DECT, etc.)
- Radar detectors
- Pagers
- Satellite television tuners (SATV)
- High frequency oscillators.

## DESCRIPTION

NPN SiGe wideband transistor for low voltage applications in a plastic, 4-pin dual-emitter SOT343R package.

## PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | emitter     |
| 2   | base        |
| 3   | emitter     |
| 4   | collector   |



## QUICK REFERENCE DATA

| SYMBOL    | PARAMETER                 | CONDITIONS  | MIN. | TYP. | MAX. | UNIT |
|-----------|---------------------------|---|------|------|------|------|
| $V_{CBO}$ | collector-base voltage    | open emitter  | –    | –    | 9    | V    |
| $V_{CEO}$ | collector-emitter voltage | open base   | –    | –    | 2.3  | V    |
| $I_C$     | collector current (DC)    |   | –    | 10   | 15   | mA   |
| $P_{tot}$ | total power dissipation   | $T_s \leq 115 \text{ }^\circ\text{C}$   | –    | –    | 35   | mW   |
| $h_{FE}$  | DC current gain           | $I_C = 10 \text{ mA}; V_{CE} = 2 \text{ V}; T_J = 25 \text{ }^\circ\text{C}$                        | 70   | 140  | 210  |      |
| $G_{max}$ | maximum power gain        | $I_C = 10 \text{ mA}; V_{CE} = 2 \text{ V}; f = 2 \text{ GHz}; T_{amb} = 25 \text{ }^\circ\text{C}$ | –    | 23   | –    | dB   |
| NF        | noise figure              | $I_C = 0.5 \text{ mA}; V_{CE} = 2 \text{ V}; f = 2 \text{ GHz}; \Gamma_S = \Gamma_{opt}$            | –    | 1.0  | –    | dB   |

## CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

## NPN SiGe wideband transistor

## BFU510

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL    | PARAMETER                      | CONDITIONS                                   | MIN. | MAX. | UNIT |
|-----------|--------------------------------|--|------|------|------|
| $V_{CBO}$ | collector-base voltage         | open emitter                                 | –    | 9    | V    |
| $V_{CEO}$ | collector-emitter voltage      | open base                                    | –    | 2.3  | V    |
| $V_{EBO}$ | emitter-base voltage           | open collector                               | –    | 2.5  | V    |
| $I_C$     | collector current (DC)         |  | –    | 15   | mA   |
| $P_{tot}$ | total power dissipation        | $T_s \leq 115\text{ °C}$ ; note 1; see Fig.2 | –    | 35   | mW   |
| $T_{stg}$ | storage temperature            |  | –65  | +150 | °C   |
| $T_j$     | operating junction temperature |  | –    | 150  | °C   |

## Note

- $T_s$  is the temperature at the soldering point of the emitter pins.

## THERMAL CHARACTERISTICS

| SYMBOL        | PARAMETER   | VALUE | UNIT |
|---------------|---|-------|------|
| $R_{th\ j-s}$ | thermal resistance from junction to soldering point | 1000  | K/W  |

## CHARACTERISTICS

$T_j = 25\text{ °C}$  unless otherwise specified.

| SYMBOL        | PARAMETER                             | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|---------------|---------------------------------------|--|------|------|------|------|
| $V_{(BR)CBO}$ | collector-base breakdown voltage      | $I_C = 2.5\ \mu\text{A}$ ; $I_E = 0$   | 9    | –    | –    | V    |
| $V_{(BR)CEO}$ | collector-emitter breakdown voltage   | $I_C = 1\ \text{mA}$ ; $I_B = 0$   | 2.3  | –    | –    | V    |
| $V_{(BR)EBO}$ | emitter-base breakdown voltage        | $I_E = 2.5\ \mu\text{A}$ ; $I_C = 0$   | 2.5  | –    | –    | V    |
| $I_{CBO}$     | collector-base leakage current        | $I_E = 0$ ; $V_{CB} = 4.5\ \text{V}$   | –    | –    | 15   | nA   |
| $h_{FE}$      | DC current gain                       | $I_C = 10\ \text{mA}$ ; $V_{CE} = 2\ \text{V}$   | 70   | 140  | 210  |      |
| $C_c$         | collector capacitance                 | $I_E = i_e = 0$ ; $V_{CB} = 2\ \text{V}$ ; $f = 1\ \text{MHz}$   | –    | 150  | –    | fF   |
| $C_{re}$      | feedback capacitance                  | $I_C = 0$ ; $V_{CB} = 2\ \text{V}$ ; $f = 1\ \text{MHz}$   | –    | 25   | –    | fF   |
| $G_{max}$     | maximum power gain; note 1            | $I_C = 10\ \text{mA}$ ; $V_{CE} = 2\ \text{V}$ ; $f = 2\ \text{GHz}$ ;<br>$T_{amb} = 25\text{ °C}$                         | –    | 23   | –    | dB   |
| NF            | noise figure                          | $I_C = 0.5\ \text{mA}$ ; $V_{CE} = 2\ \text{V}$ ; $f = 2\ \text{GHz}$ ;<br>$\Gamma_S = \Gamma_{opt}$                       | –    | 1.0  | –    | dB   |
| $P_{L1}$      | output power at 1 dB gain compression | $I_C = 5\ \text{mA}$ ; $V_{CE} = 2\ \text{V}$ ; $f = 2\ \text{GHz}$ ;<br>$Z_S = Z_{S\ opt}$ ; $Z_L = Z_{L\ opt}$ ; note 2  | –    | 2    | –    | dBm  |
| ITO           | third order intercept point           | $I_C = 10\ \text{mA}$ ; $V_{CE} = 2\ \text{V}$ ; $f = 2\ \text{GHz}$ ;<br>$Z_S = Z_{S\ opt}$ ; $Z_L = Z_{L\ opt}$ ; note 2 | –    | 7    | –    | dBm  |

## Notes

- $G_{max}$  is the maximum power gain, if  $K > 1$ . If  $K < 1$  then  $G_{max} = \text{MSG}$ .
- $Z_S$  and  $Z_L$  are optimized for gain.

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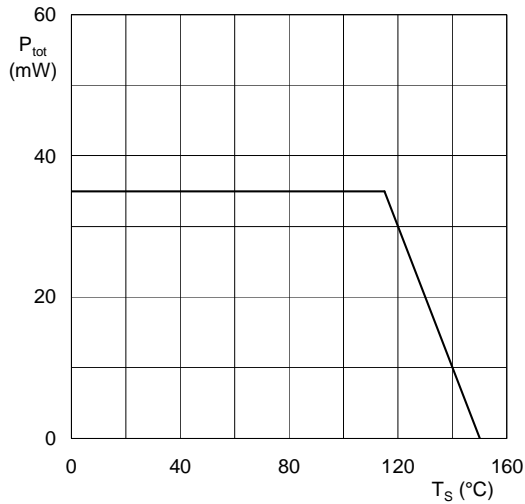
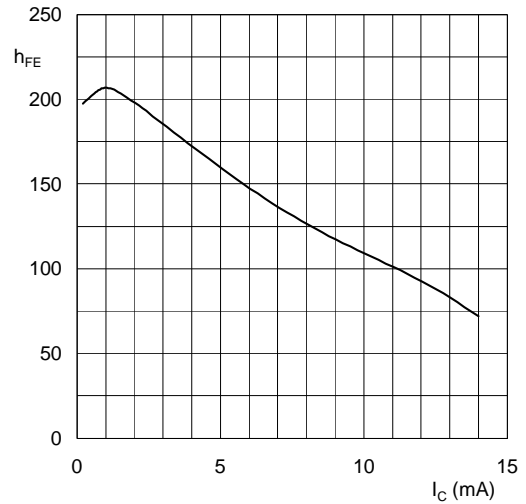


Fig.2 Power derating curve.



$V_{CE} = 2$  V;  $T_j = 25$   $^{\circ}C$ .

Fig.3 DC current gain as a function of collector current; typical values.

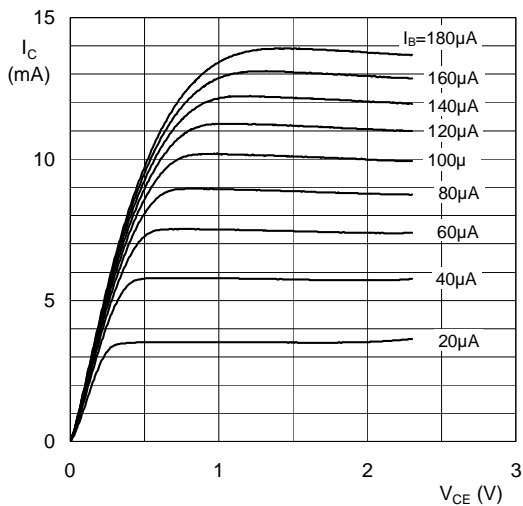
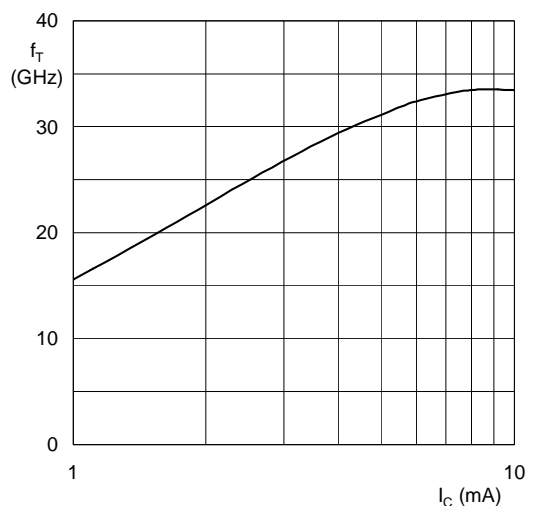


Fig.4 Output characteristics; typical values.

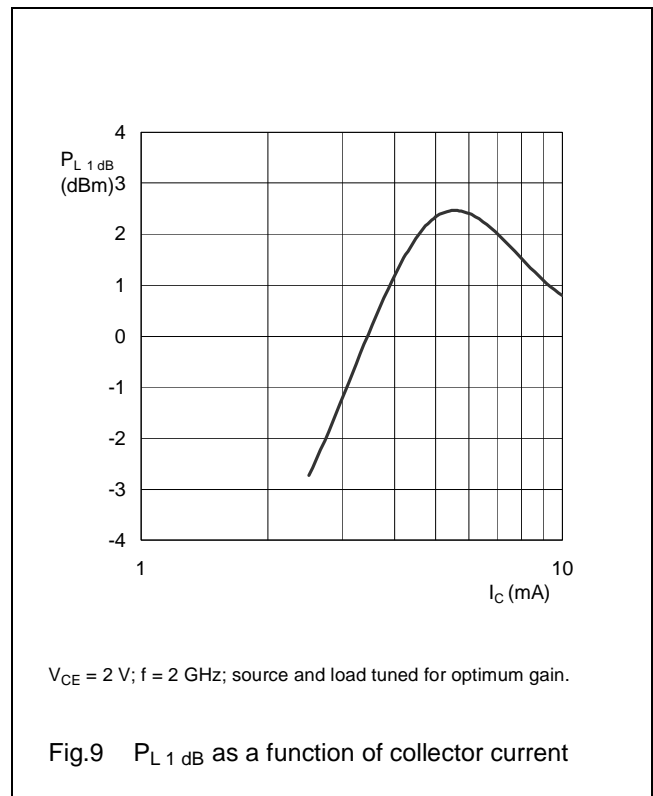
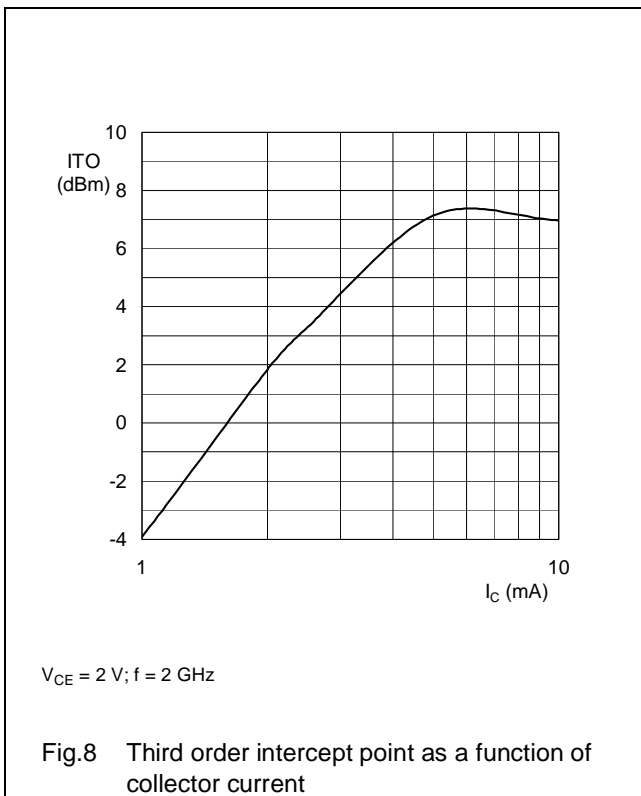
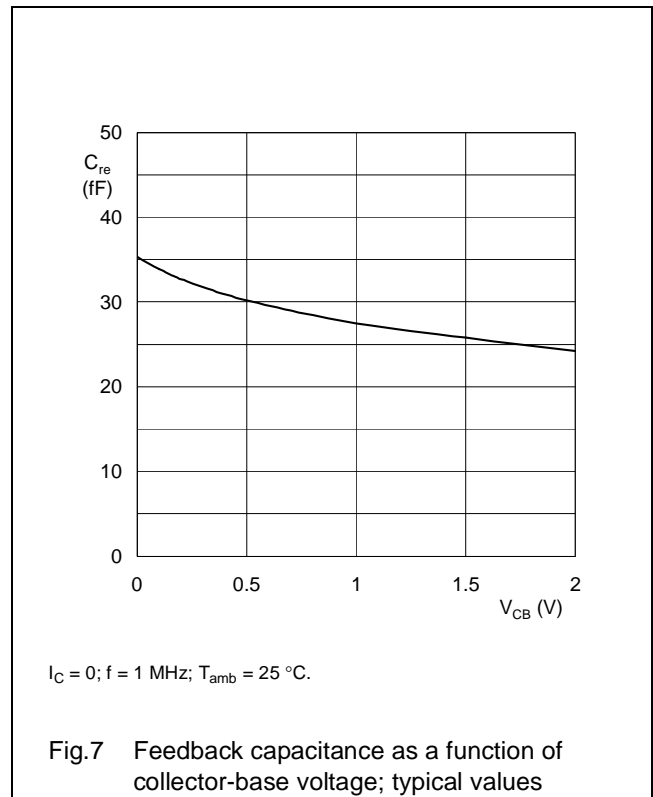
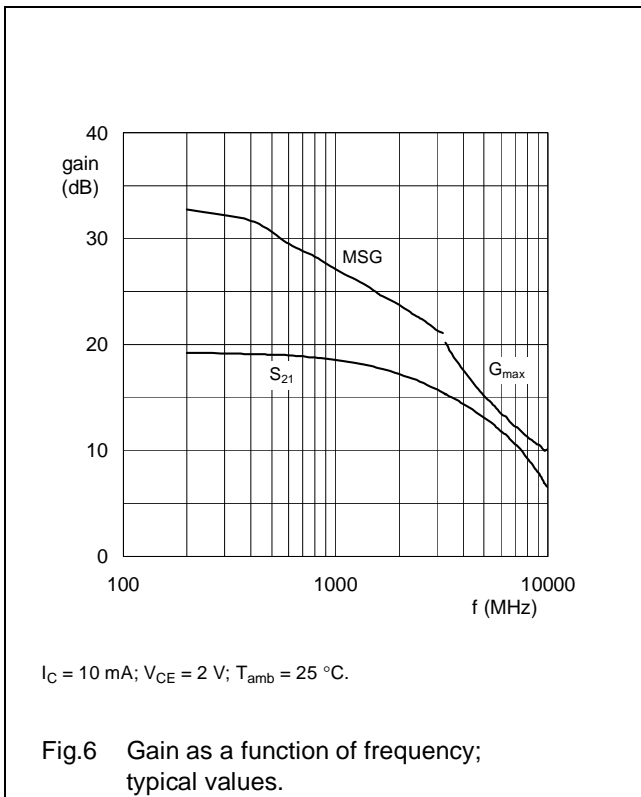


$V_{CB} = 1$  V;  $f = 2$  GHz;  $T_{amb} = 25$   $^{\circ}C$

Fig.5 Transition frequency as a function of collector current; typical values.

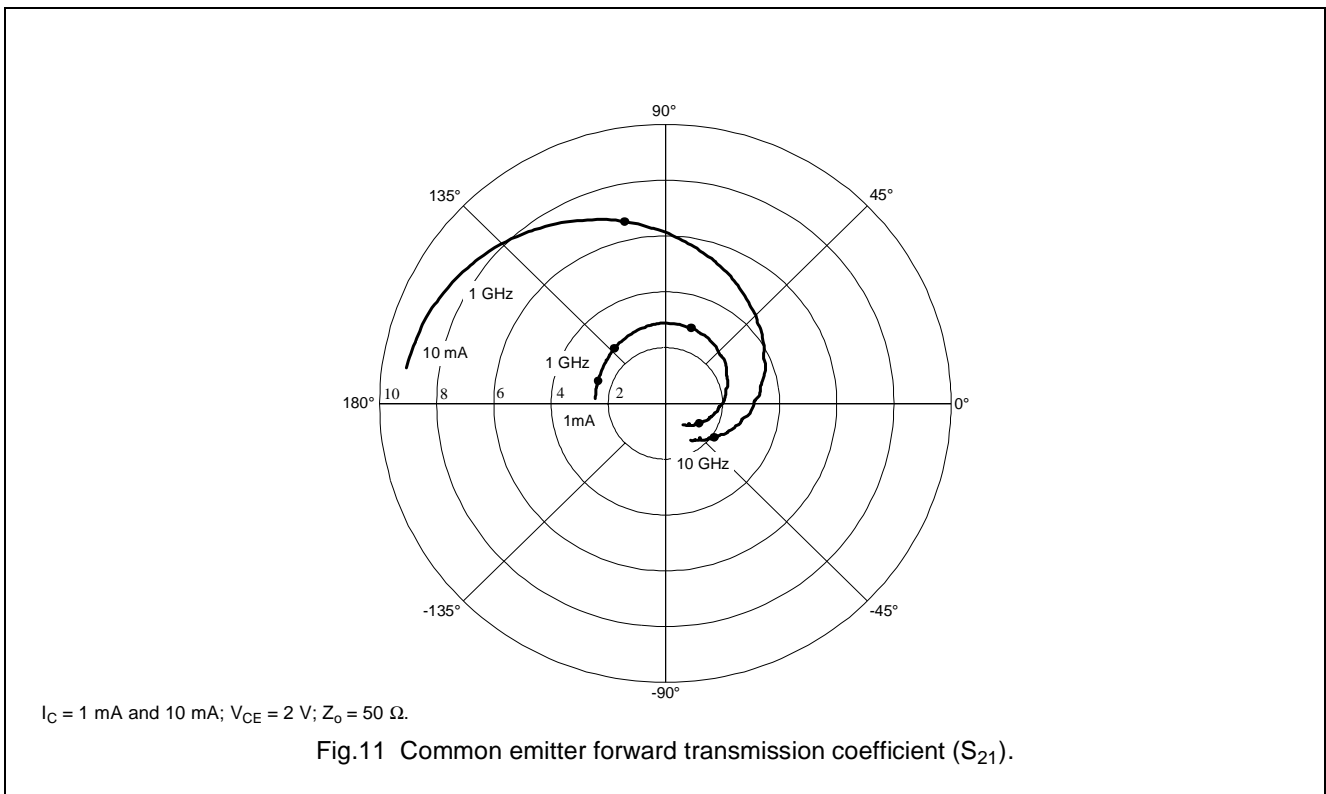
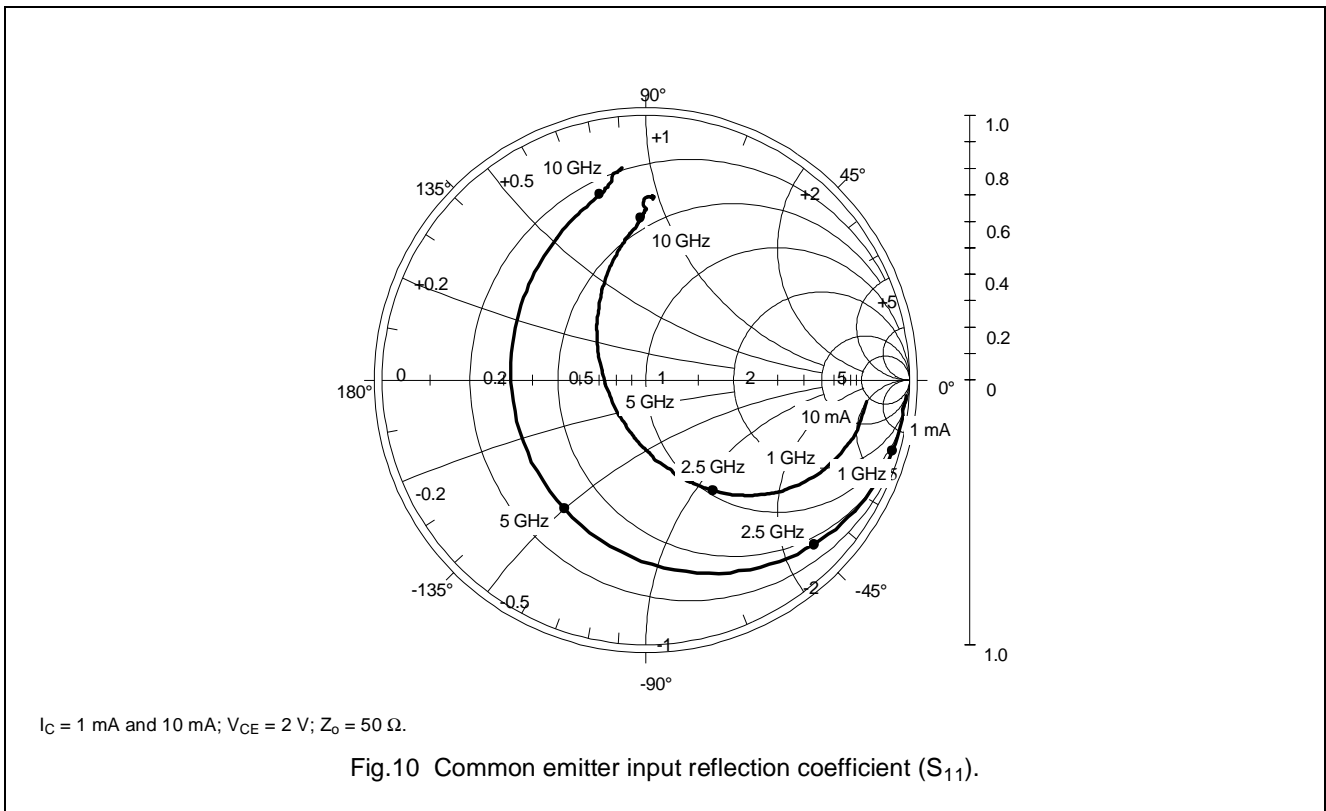
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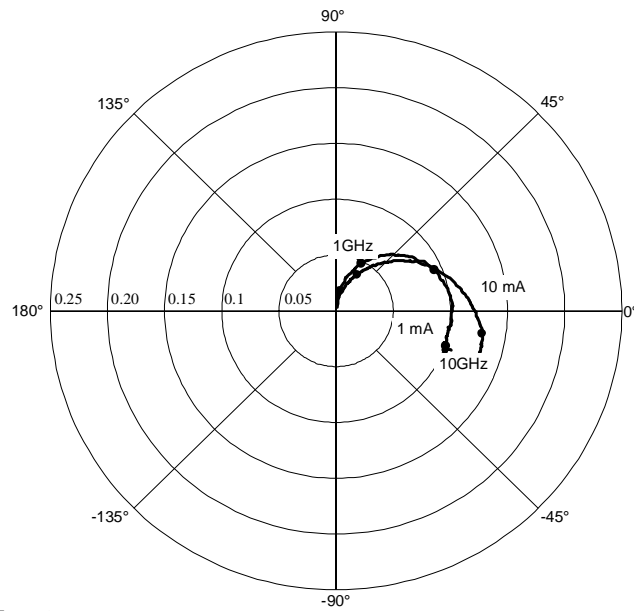
NPN SiGe wideband transistor

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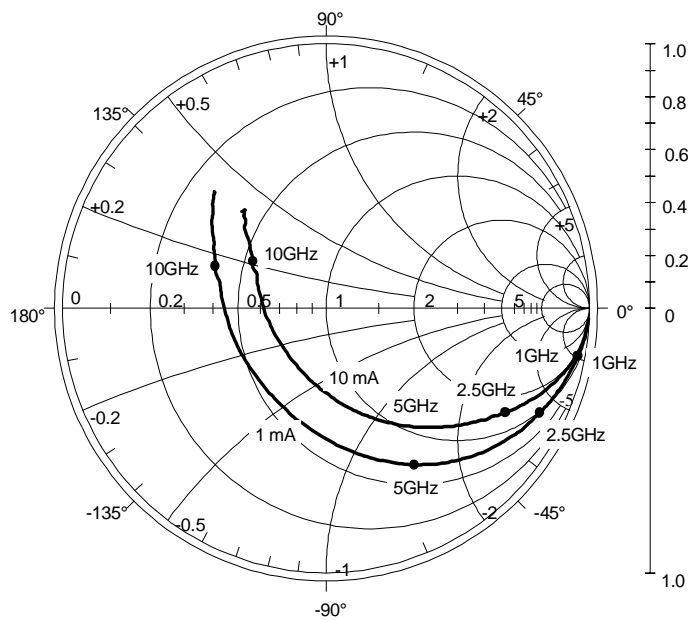
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$I_C = 1 \text{ mA}$  and  $10 \text{ mA}$ ;  $V_{CE} = 2 \text{ V}$ ;  $Z_o = 50 \Omega$ .

Fig.12 Common emitter reverse transmission coefficient ( $S_{12}$ ).

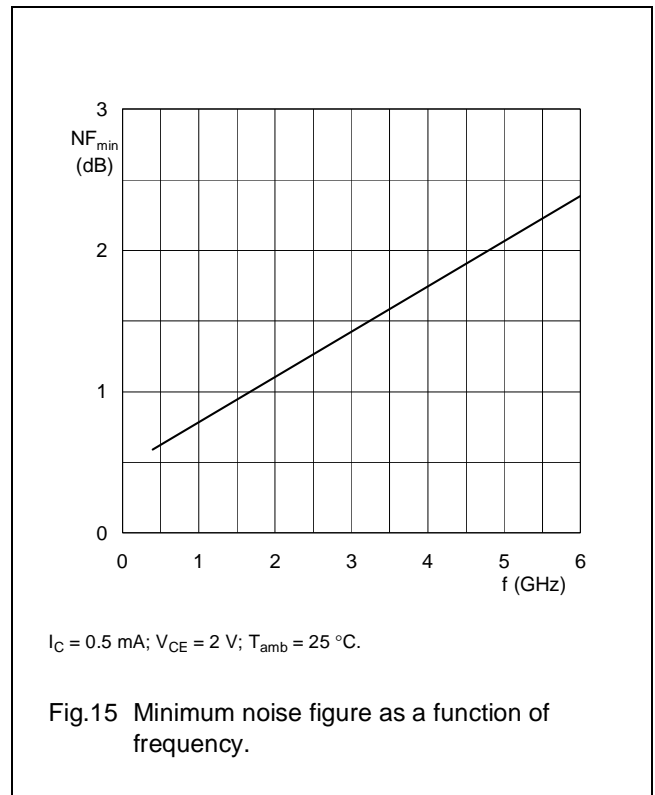
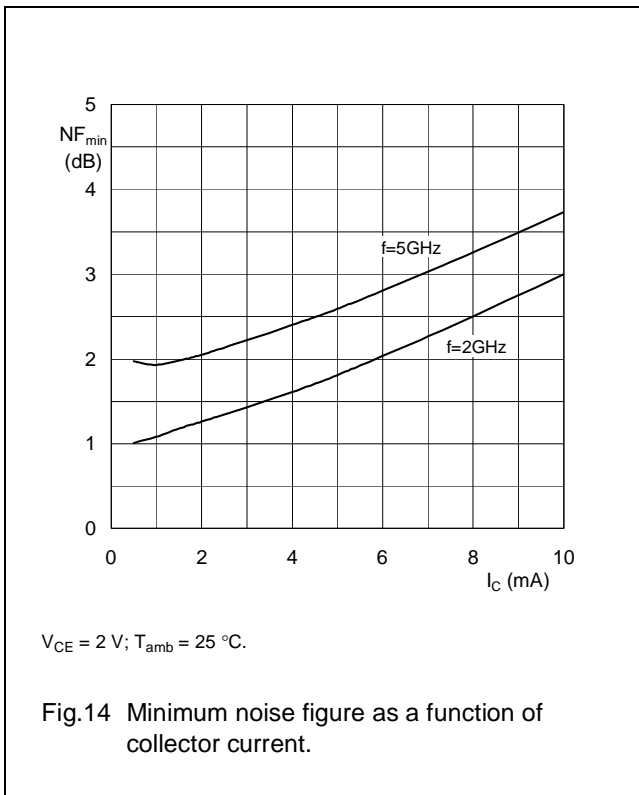


$I_C = 1 \text{ mA}$  and  $10 \text{ mA}$ ;  $V_{CE} = 2 \text{ V}$ ;  $Z_o = 50 \Omega$ .

Fig.13 Common emitter output reflection coefficient ( $S_{22}$ ).

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Noise data:  $V_{CE} = 2\text{ V}; I_C = 1\text{ mA}; T_{amb} = 25\text{ }^{\circ}\text{C};$  typical values

| f (GHz) | F <sub>min</sub> (dB) | Γ <sub>opt</sub> |        | r <sub>n</sub> (Ω) |
|---------|-----------------------|------------------|--------|--------------------|
|         |                       | (mag)            | (deg)  |                    |
| 2       | 1.2                   | 0.79             | 36.5   | 1.07               |
| 3       | 1.5                   | 0.72             | 57.9   | 0.84               |
| 4       | 1.9                   | 0.60             | 81.2   | 0.60               |
| 5       | 2.2                   | 0.55             | 103.7  | 0.36               |
| 6       | 2.5                   | 0.43             | 133.7  | 0.22               |
| 7       | 2.7                   | 0.30             | 168.3  | 0.18               |
| 8       | 3.0                   | 0.27             | -152.7 | 0.23               |
| 9       | 3.2                   | 0.27             | -103.2 | 0.42               |
| 10      | 3.3                   | 0.33             | -62.8  | 0.71               |
| 11      | 3.4                   | 0.43             | -38.5  | 0.96               |
| 12      | 3.5                   | 0.46             | -16.0  | 1.25               |



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SPICE parameters for the BFU510 die

| SEQUENCE No. | PARAMETER | VALUE   | UNIT       |
|--------------|-----------|---------|------------|
| 1            | IS        | 0.277   | aA         |
| 2            | BF        | 270     | –          |
| 3            | NF        | 1.06077 | –          |
| 4            | VAF       | 45      | V          |
| 5            | IKF       | 11.1    | mA         |
| 6            | ISE       | 265     | fA         |
| 7            | NE        | 2.9     | –          |
| 8            | BR        | 50      | –          |
| 9            | NR        | 1.01    | –          |
| 10           | VAR       | 1000000 | V          |
| 11           | IKR       | 0.001   | A          |
| 12           | ISC       | 0.4     | fA         |
| 13           | NC        | 1.21    | –          |
| 14           | RB        | 21      | $\Omega$   |
| 15 (1)       | IRB       | –       | –          |
| 16           | RBM       | 30      | $\Omega$   |
| 17           | RE        | 4.36    | m $\Omega$ |
| 18           | RC        | 20.5    | $\Omega$   |
| 19           | XTB       | -2.2    | –          |
| 20           | EG        | 1.014   | eV         |
| 21           | XTI       | 3       | –          |
| 22           | CJE       | 54.3    | fF         |
| 23           | VJE       | 877     | mV         |
| 24           | MJE       | 0.202   | –          |
| 25           | TF        | 2.8     | ps         |
| 26           | XTF       | 0.9     | –          |
| 27           | VTF       | 0.026   | V          |
| 28           | ITF       | 0.9     | A          |
| 29           | PTF       | 30      | deg        |
| 30           | CJC       | 30      | fF         |
| 31           | VJC       | 577     | mV         |
| 32           | MJC       | 0.239   | –          |
| 33           | XCJC      | 0.44    | –          |
| 34           | TR        | 20      | ns         |
| 35           | CJS       | 8.84    | fF         |
| 36           | VJS       | 500     | mV         |
| 37           | MJS       | 0.6447  | –          |
| 38           | FC        | 0.7     | –          |

Notes

1. Not used.

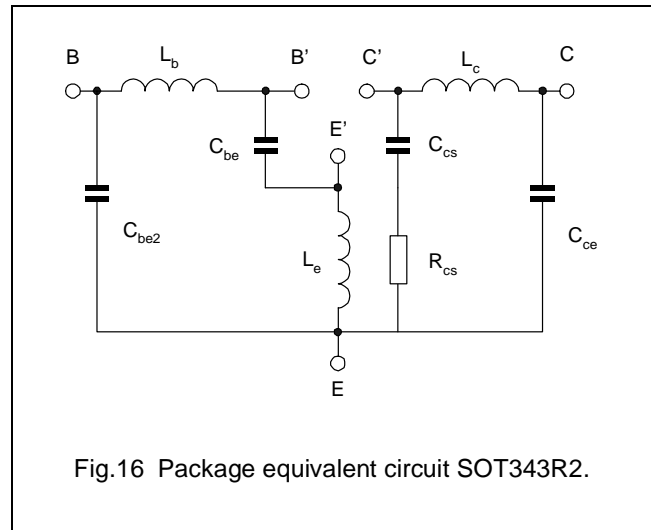


Fig.16 Package equivalent circuit SOT343R2.

List of components (see fig 16)

| DESIGNATION | VALUE | UNIT |
|-------------|-------|------|
| $L_b$       | 0.90  | nH   |
| $L_c$       | 1.02  | nH   |
| $L_e$       | 0.33  | nH   |
| $C_{be1}$   | 133   | fF   |
| $C_{be2}$   | 65    | fF   |
| $C_{ce}$    | 66    | fF   |
| $C_{cs}$    | 100   | fF   |
| $R_{cs}$    | 170   | Ohm  |

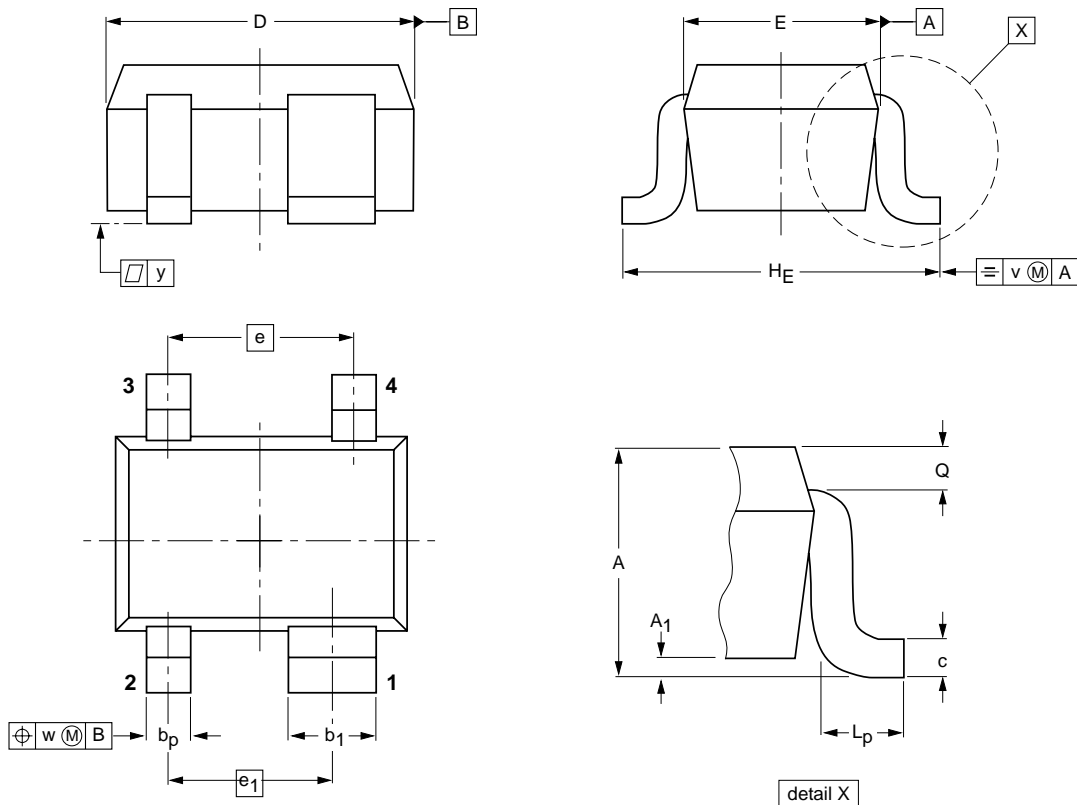
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PACKAGE OUTLINE

Plastic surface mounted package; reverse pinning; 4 leads

SOT343R



DIMENSIONS (mm are the original dimensions)

| UNIT | A          | A <sub>1</sub><br>max | b <sub>p</sub> | b <sub>1</sub> | c            | D          | E            | e   | e <sub>1</sub> | H <sub>E</sub> | L <sub>p</sub> | Q            | v   | w   | y   |
|------|------------|-----------------------|----------------|----------------|--------------|------------|--------------|-----|----------------|----------------|----------------|--------------|-----|-----|-----|
| mm   | 1.1<br>0.8 | 0.1                   | 0.4<br>0.3     | 0.7<br>0.5     | 0.25<br>0.10 | 2.2<br>1.8 | 1.35<br>1.15 | 1.3 | 1.15           | 2.2<br>2.0     | 0.45<br>0.15   | 0.23<br>0.13 | 0.2 | 0.2 | 0.1 |

| OUTLINE<br>VERSION | REFERENCES |       |      |  | EUROPEAN<br>PROJECTION | ISSUE DATE |
|--------------------|------------|-------|------|--|------------------------|------------|
|                    | IEC        | JEDEC | EIAJ |  |                        |            |
| SOT343R            |            |       |      |  |                        | 97-05-21   |

## NPN SiGe wideband transistor

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## DATA SHEET STATUS

| DATA SHEET STATUS <sup>(1)</sup> | PRODUCT STATUS <sup>(2)</sup> | DEFINITIONS  |
|----------------------------------|-------------------------------|--|
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